## SKiiP 632GB120-3D



## 2-pack - integrated intelligent Power System

**Power section** 

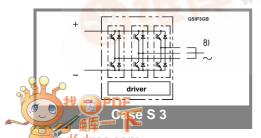
SKiiP 632GB120-3D

#### **Features**

- SKiiP technology inside
- CAL diode technology
- Integrated current sensor
- Integrated temperature sensor
- · Integrated heat sink
- IEC 60721-3-3 (humidity) class 3K3/IE32 (SKiiP<sup>®</sup> 2 System)
- IEC 60068-1 (climate) 40/125/56
- UL recognized file no. E63532
- with assembly of suitable MKP capacitor per terminal (SEMIKRON type is recommended)
- AC connection busbars must be connected by the user; copper busbars available on request

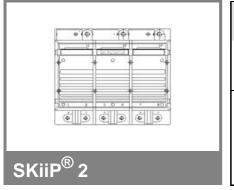
Absolute	Maximum Ratings	T <sub>s</sub> = 25 °C unless otherwise	°C unless otherwise specified			
Symbol	Conditions	Values	Units			
IGBT	42 m					
V <sub>CES</sub>	MADE	1200	V			
V <sub>CC</sub> 1)	Operating DC link voltage	900	V			
V <sub>CES</sub> V <sub>CC</sub> 1) V <sub>GES</sub>		± 20	V			
I <sub>C</sub>	T <sub>s</sub> = 25 (70) °C	600 (450)	Α			
Inverse diode						
$I_F = -I_C$	T <sub>s</sub> = 25 (70) °C	600 (450)	Α			
I <sub>FSM</sub>	$T_{j} = 150  ^{\circ}\text{C},  t_{p} = 10  \text{ms};  \text{sin}.$	4320	Α			
I²t (Diode)	Diode, T <sub>j</sub> = 150 °C, 10 ms	93	kA²s			
$T_j$ , $(T_{stg})$	400	- 40 (- 25) + 150 (125)	°C			
V <sub>isol</sub>	AC, 1 min. (mainterminals to heat sink)	3000	V			

Characte	eristics		$I_s = 25^{\circ}$	C unless	otherwise	specifie	
Symbol	Conditions		min.	typ.	max.	Units	
GBT							
√ <sub>CEsat</sub>	$I_C = 525 \text{ A}, T_j = 25 (125) ^{\circ}\text{C}$			2,6 (3,1)	3,1	V	
√ <sub>CEO</sub>	$T_j = 25 (125)^{\circ} C$			1,2 (1,3)		V	
CE	T <sub>j</sub> = 25 (125) °C		100	2,5 (3,3)		mΩ	
CES	$V_{GE} = 0 V, V_{CE} = V_{CES},$		- 4	(30)	1,2	mA	
	T <sub>j</sub> = 25 (125) °C						
e <sub>on</sub> + E <sub>off</sub>	I <sub>C</sub> = 525 A, V <sub>CC</sub> = 600 V				158	mJ	
	T <sub>i</sub> = 125 °C, V <sub>CC</sub> = 900 V				278	mJ	
R <sub>CC'+EE'</sub>	terminal chip, T <sub>i</sub> = 125 °C			0,17		mΩ	
CE	top, bottom			5		nH	
CHC	per phase, AC-side			4,2		nF	
nverse	diode		ı				
$V_F = V_{FC}$	I <sub>F</sub> = 450 A, T <sub>i</sub> = 25 (125) °C			2,1 (2)	2,6	V	
V <sub>TO</sub>	T <sub>i</sub> = 25 (125) °C			1,3 (1)	1,4 (1,1)	V	
 T	T <sub>i</sub> = 25 (125) °C		- 10	1,7 (2)	2,3 (2,6)	mΩ	
= rr	$I_C = 525 \text{ A}, V_{CC} = 600 \text{ V}$		_ 4		18	mJ	
	$T_j = 125 ^{\circ}\text{C},  V_{CC} = 900 ^{\circ}\text{V}$		12.14		23	mJ	
Mechani	cal data					•	
M <sub>dc</sub>	DC terminals, SI Units		6		8	Nm	
M <sub>ac</sub>	AC terminals, SI Units		13		15	Nm	
N	SKiiP® 2 System w/o heat sink			2,7		kg	
N T	heat sink			6,6		kg	
Thermal	characteristics (P16 heat	sink; 2	95 m <sup>3</sup> /h)	; " ृ" refe	rence to		
	ture sensor		_	ı			
$R_{th(j-s)I}$	per IGBT				0,043	K/W	
$R_{th(j-s)D}$	per diode		4.00		0,125	K/W	
$R_{th(s-a)}$	per module		- C	3-51	0,036	K/W	
Z <sub>th</sub>	R <sub>i</sub> (mK/W) (max. values)	N F		tau <sub>i</sub> (s)			
	1 2 3	4	1	2	3	4	
Z th(j-r)I	5 33 5	0	1	0,13	0,001	1	
Z th(j-r)D	14 96 15	0	1	0,13	0,001	1	
Z th(r-a)	11,1 18,3 3,5	3,1	204	60	6	0,02	



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### SKiiP 632GB120-3D



Absolute	Maximum Ratings T <sub>a</sub>	<sub>a</sub> = 25 °C unless otherwise specified		
Symbol	Conditions	Values	Units	
$V_{S1}$	stabilized 15 V power supply	18	V	
$V_{S2}$	unstabilized 24 V power supply	30	V	
$V_{iH}$	input signal voltage (high)	15 + 0,3	V	
dv/dt	secondary to primary side	75	kV/μs	
$V_{isollO}$	input / output (AC, r.m.s., 2s)	3000	Vac	
V <sub>isol12</sub>	output 1 / output 2 (AC, r.m.s., 2s)	1500	Vac	
f <sub>sw</sub>	switching frequency	20	kHz	
f <sub>out</sub>	output frequency for I=I <sub>C</sub> ;sin.	1	kHz	
$T_{op} (T_{stg})$	operating / storage temperature	- 40 <b>+</b> 85	°C	

# 2-pack - integrated intelligent Power System

2-pack integrated gate driver

SKiiP 632GB120-3D

#### **Gate driver features**

- CMOS compatible inputs
- Wide range power supply
- Integrated circuitry to sense phase current, heat sink temperature and DC-bus voltage (option)
- Short circuit protection
- Over current protection
- Over voltage protection (option)
- Power supply protected against under voltage
- · Interlock of top/bottom switch
- Isolation by transformers
- Fibre optic interface (option for GB-types only)
- IEC 60068-1 (climate) 25/85/56

Characteristics				(T <sub>a</sub> = 25 °C)		
Symbol	Conditions	min.	typ.	max.	Units	
V <sub>S1</sub>	supply voltage stabilized	14,4	15	15,6	V	
$V_{S2}$	supply voltage non stabilized	20	24	30	V	
I <sub>S1</sub>	V <sub>S1</sub> = 15 V	260+39	260+390*f/f <sub>max</sub> +1,2*(I <sub>AC</sub> /A)			
I <sub>S2</sub>	V <sub>S2</sub> = 24 V	200+260	)*f/f <sub>max</sub> +0,8	5*(I <sub>AC</sub> /A)	mA	
V <sub>iT+</sub>	input threshold voltage (High)			12,3	V	
$V_{iT-}$	input threshold voltage (Low)	4,6			V	
R <sub>IN</sub>	input resistance		10		kΩ	
t <sub>d(on)IO</sub>	input-output turn-on propagation time			1,5	μs	
$t_{d(off)IO}$	input-output turn-off propagation time			1,4	μs	
$t_{pERRRESET}$	error memory reset time	9			μs	
$t_{TD}$	top / bottom switch : interlock time		3,3		μs	
I <sub>analogOUT</sub>	8 V corresponds to max. current of 15 V supply voltage		600		Α	
I <sub>Vs1outmax</sub>	(available when supplied with 24 V)			50	mA	
I <sub>A0max</sub>	output current at pin 12/14			5	mA	
$V_{0I}$	logic low output voltage			0,6	V	
$V_{0H}$	logic high output voltage			30	V	
I <sub>TRIPSC</sub>	over current trip level (I <sub>analog OUT</sub> = 10 V)		750		Α	
I <sub>TRIPLG</sub>	ground fault protection				Α	
T <sub>tp</sub>	over temperature protection	110		120	°C	
U <sub>DCTRIP</sub>	trip level of U <sub>DC</sub> -protection	900			V	
	( U <sub>analog OUT</sub> = 9 V); (option)					

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